

Standalone Linear Lithium Battery Charger With Thermal Regulation

■ INTRODUCTION

The SMC4008H is a complete constant-current/ constant-voltage linear charger for single cell lithium rechargeable battery. No external sense resistor is needed, and no blocking diode is required due to the internal P-MOSFET architecture. Furthermore, the SMC4008H is specifically designed to work within USB power specifications. Its low external component count makes the SMC4008H ideally suited for portable applications. Thermal feedback regulates the charge current to limit the die temperature during high power operation or high ambient temperature. The charge current can be programmed externally with a single resistor. The SMC4008H automatically terminates the charge cycle when the charge current drops to 1/10th the programmed value after the final float voltage is reached. When the input supply (wall adapter or USB supply) is removed, the SMC4008H automatically enters a low power sleep mode, dropping the battery drain current to less than 2μA. The SMC4008H can be put into shutdown mode, reducing the supply current to 50µA. Other features include battery pack temperature monitor, undervoltage lockout, automatic recharge and two status pins to indicate charging and charge termination. The SMC4008H is available in thermally enhanced SOT package.

■ FEATURES

- Charges Single Cell Lithium Battery Directly from USB Port or AC Adapter
- Input Voltage Range From 4.5V to 24V
- Input OVP: 6.5V
- No External MOSFET, Sense Resistor or Blocking Diode Required
- Preset 4.20V / 4.35V / 4.40V Charge Voltage
- Continuous Programmable Charge Current Up to 600mA
- Precharge Conditioning for Reviving Deeply Discharged Cells and Minimizing Hear Dissipation during Initial Stage of Charge
- Constant-Current/Constant-Voltage/Constant-Temp Operation with Thermal Regulation to Maximize Charge Rate Without Risk of Overheating
- Battery Reverse Protection
- Automatic Recharge
- Charge state pairs of output, no battery and fault status display
- Charge Current Monitor Output for Gas Gauging
- Automatic Low Power Sleep Mode When Input Supply Voltage is Removed
- Soft-Start Limits Inrush Current

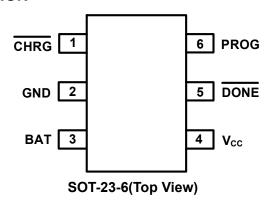
■ APPLICATIONS

- Cellular phones, PDAs
- Portable Media Players
- Digital Still Cameras
- Bluetooth & GPS Applications
- Mobile Internet Device
- Charging Docks and Cradles

■ ORDER INFORMATION SMC4008H123456

DESIGNATOR	SYMBOL	DESCRIPTION	
1)	-	A Version Number	
2	A Standard		
345	Integer	Output Voltage e.g.4.20V=③: 4, ④: 2, ⑤: 0	
@	M	Package: SOT-23-5	
6	E	Package: SOT-23-6	

■ PIN CONFIGURATION



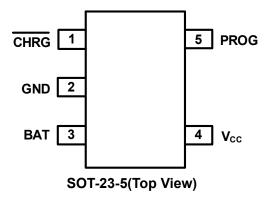
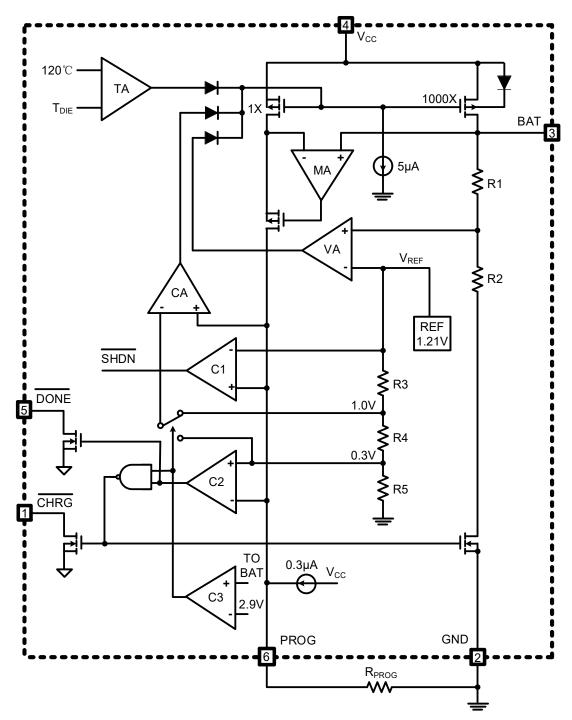


Table 1. Pin Description (SOT-23-6)

PIN NO.	PIN NAME	FUNCTION
		Open Drain Charge Status Output. When the battery is being
1	CHRG	charged, the CHRG pin is pulled low by an internal switch,
		otherwise CHRG pin is in high impedance state.
2	GND	Ground Terminal.
		Charger Power Stage Current Output and Battery Voltage
		Sense Input. BAT pin provides charge current to the battery and
		regulates the final float voltage. An internal precision resistor
3	BAT	divider from this pin sets the float voltage which is disconnected in
3	DAI	shutdown mode. Connect the positive terminal of the battery to
		BAT pin. Bypass BAT to GND with 10μF to 47μF capacitor. BAT
		pin draws less than 2μA current in chip disable mode or in sleep
		mode.
		Positive Input Supply Voltage. Vcc is the power supply to the
		internal circuit. Vcc can range from 4.5V to 24V and should be
4	Vcc	bypassed with at least a 4.7μF capacitor. When V _{CC} drops to
4		within 80mv of the BAT pin voltage or Vcc>VovP, SMC4008H
		enters low power sleep mode, dropping BAT pin's current to less
		than 2μA.
		Open-Drain Charge termination Status Output. In charge
5	DONE	termination status, DONE is pulled low by an internal switch;
		Otherwise DONE pin is in high impedance state.
		Constant Charge Current Setting and Charge Current Monitor
		Pin . The charge current is set by connecting a 1% accuracy metal
		film resistor R _{PROG} from this pin to GND. When charging in
6	PROG	precharge mode, the PROG pin voltage is regulated to 0.3V.
U		When charging in constant-current mode, the PROG pin voltage
		is regulated to 1V. In all modes during charging, the voltage on
		PROG pin can be used to measure the charge current as the
		following formula: I _{BAT} =(V _{PROG} /R _{PROG}) X 1000

■ BLOCK DIAGRAM



Future 1 Functional Block Diagram

■ ABSOLUTE MAXIMUM RATINGS(1)

(Unless otherwise specified, $T_A = 25^{\circ}C$)

PARAMETER	SYMBOL	RATINGS	UNITS
Input Supply Voltage ⁽²⁾	V_{CC}	-0.3 ~ 28	
PROG Pins Voltage ⁽²⁾		-0.3 ~ 7.0	V
BAT Pin Voltage ⁽²⁾		-5 ~ 12	V
CHRG DONE Pins Voltage ⁽²⁾		-0.3 ~ 28	
BAT Short-Circuit Duration	-	Continuous	-
BAT Pin Output Current (Continuous)	I _{BAT}	800	mA
Output sink current	ICHRG, IDONE	10	mA
Power dissipation	P _D	400	mW
Operating Ambient Temperature Range ⁽³⁾	TA	-40 ~ +85	°C
Junction Temperature	TJ	-40 ~ +150	°C
Storage Temperature	T_{stg}	-55 ~ +150	°C
Lead Temperature (Soldering, 10s)	T _{solder}	260	°C
ESD rating ⁽⁴⁾	HBM	≥ 2000	V
ESD Talling(*)	MM	≥ 200	V

- (1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods my affect device reliability.
- (2) All voltages are with respect to network ground terminal.
- (3) The SMC4008H are guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.
- (4) The human body model is a 100pF capacitor discharged through a 1.5k Ω resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN	MAX	UNITS
Input voltage range ⁽⁵⁾	Vcc	4.5	24	V
BAT Pin Output Current (Continuous)	I _{BAT}		600(6)	mA
Fast-charge current programming resistor ⁽⁷⁾	R _{PROG}	1.66	50	kΩ

- (5) If V_{CC} is between UVLO and 4.5V, and above the battery voltage, then the IC is active (can deliver some charge to the battery), but the IC will have limited or degraded performance (some functions may not meet data sheet specifications). The battery may be undercharged (V_{FLOAT} less than in the specification), but will not be overcharged (V_{FLOAT} will not exceed specification).
- (6) The thermal regulation feature reduces charge current if the IC's junction temperature reaches 125°C; Thus without a good thermal design the maximum programmed charge current may not be reached.
- (7) Use a 1% tolerance metal film resistor for R_{PROG} to avoid issues with the R_{PROG} short test when using the maximum charge current setting.



■ ELECTRICAL CHARACTERISTICS

($V_{CC} = 5V$, $T_A = 25$ °C, Test Circuit Figure2, unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Supply Voltage			4.5		24	V
Input Over-Voltage Protection Voltage	V _{ovp}	Vcc Rising, Hys = 0.27V	6.1	6.5	6.9	V
Input Voltage Range for Charging			4.5		6.0	V
V _{CC} Under voltage Lockout Threshold	V _{UVL}	V _{CC} from Low to High		3.9		V
V _{CC} Under voltage Lockout Hysteresis	ΔVυνι			150		mV
		Charge Mode, R _{PROG} = 10K		150	500	
Input Supply Current	Icc	Standby Mode (Charge Terminated)		75	150	μΑ
		Shutdown Mode: R _{PROG} Not Connected, V _{CC} < V _{BAT} , or V _{CC} < V _{UVL}		50	100	
Trickle Charge Threshold	VTRIKL	R _{PROG} = 10K, V _{BAT} Rising		2.9		V
Trickle Charge Hysteresis	ΔV _{TRIKL}	R _{PROG} = 10K		100		mV
Trickle Charge Current	ITRIKL	R _{PROG} = 2K	45	50	55	mA
		R _{PROG} = 2K, Current Mode (V _{BAT} = 3.8V)	450	500	550	mA
BAT Pin Current	Іват	Standby Mode, V _{BAT} = V _{FLOAT}	0	-2.0	-6.0	
		Shutdown Mode (R _{PROG} Not Connected)		±1	±2	μΑ
		Sleep Mode, V _{CC} = 0V			-1	
PROG Pin Voltage	V _{PROG}	R _{PROG} = 1K, Current Mode	0.9	1.0	1.1	V
PROG Pin Pull-Up Current	IPROG			0.3		μΑ
	VFLOAT	$0^{\circ}C \le T_{A} \le 85^{\circ}C,$ $I_{BAT} = 45\text{mA}, R_{PROG} = 10\text{K}$	4.158	4.200	4.250	V
Regulated Output (Float) Voltage			4.300	4.350	4.400	V
(i loat) voltage			4.350	4.400	4.450	V
1C/10 Termination Current Threshold	I _{TERM}	R _{PROG} = 2K		0.1		mA/mA

■ ELECTRICAL CHARACTERISTICS(continued)

(Vcc = 5V, T_A= 25°C, Test Circuit Figure2, unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Recharge Battery Threshold	$\triangle V_{RECHG}$	V _{FLOAT} —V _{RECHG}		150		mV
Recharge Comparator Filter Time	trecharge	V _{BAT} High to Low		0.8		mS
V _{CC} -V _{BAT} Lockout Threshold	۸	Vcc from Low to High		100		mV
VCC-VBAT LOCKOUT THESHOID	Amsd	Vcc from High to Low		80		mV
CHRG Pin Voltage	VCHRG	I _{CHRG} = 5mA		0.3		V
DONE Pin Voltage	VDONE	IDONE = 5mA		0.3		V
Power FET "ON"						
Resistance	Ron	$I_{BAT} = 600 \text{mA}$		1000		mΩ
(Between V _{CC} and BAT)						
Junction Temperature in						
Constant Temperature	T _{J(REG)}			140		°C
Mode						

■ TYPICAL APPLICATION CIRCUIT

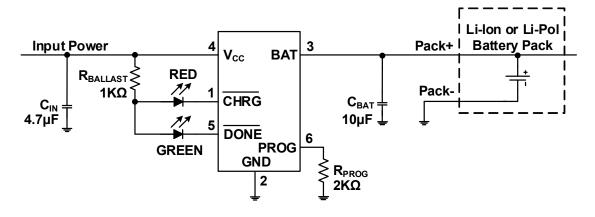


Figure 2 Standard Application Circuit

FUNCTIONAL DESCRIPTION

The SMC4008H series are highly integrated Li-Ion or Li-Pol linear battery chargers, targeted at space-limited portable applications. It operates from either a USB port or Wall Adapter and charges a single-cell Li-Ion or Li-Pol battery with up to 1000mA of charge current.

The charge current is programmable using external components (RPROG resistor). The charge process starts when an external input power is connected to the system, V_{CC} > V_{UVL}, V_{CC} > V_{BAT} + V(SLP EXIT), the charger is enabled by the RPROG resistor connected and the battery voltage is below the recharge threshold, V_{BAT} < V_{RECHG}.

When the charger is enabled two control loops modulate the battery switch drain to source impedance to limit the BAT pin current to the programmed charge current value (charge current loop) or to regulate the BAT pin voltage to the programmed charge voltage value (charge voltage loop). If VBAT < VTRIKL (2.9V typical), the BAT pin current is internally set to 3/10th of the programmed fast-charge current value in current regulation mode.

The SMC4008H series provide battery charge status via CHRG & DONE status pins. CHRG & DONE pins are internally connected to an N-channel open drain MOSFET.

The open drain status output that is not used should be tied to ground.

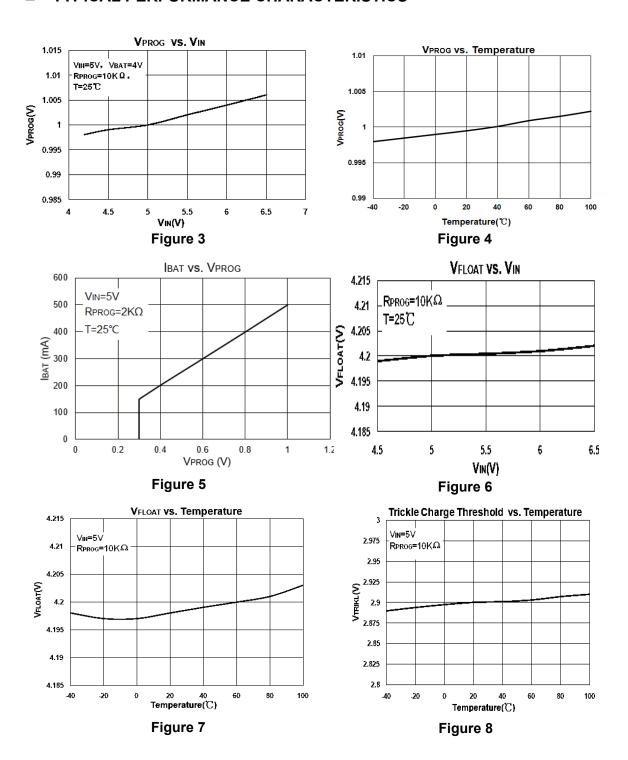
The following table lists the indicator status and its corresponding charging state.

Table 1. Charge Status Indicator (1)

Charge State Description	CHRG	DONE	
Preconditioning-Current Mode (Trickle) Charge	ON	HI-Z	
Constant-Current Mode (Fast) Charge	ON	HI-Z	
Constant-Voltage Mode (Taper) Charge, IBAT > ITERM	ON	HI-Z	
Charge Temination (I _{BAT} < I _{TERM} , Charge Done)	HI-Z	ON	
Power Down (Undervoltage Lockout) Mode	HI-Z	HI-Z	
Sleep Mode (Vuvl < Vcc < VBAT + V(SLP_EXIT),	HI-Z	HI-Z	
or the Vcc is removed)	ПІ-Д	∏I - ∠	
Shutdown Mode (PROG pin floating)	HI-Z	HI-Z	
OVP Mode (V _{CC} > V _{OVP})	HI-Z	HI-Z	
No bottom with Charge Enghlad	FLASH Rate	FLACII	
No battery with Charge Enabled	depends on CBAT	FLASH	
Fault Condition (Battery Short Circuit)	ON	HI-Z	

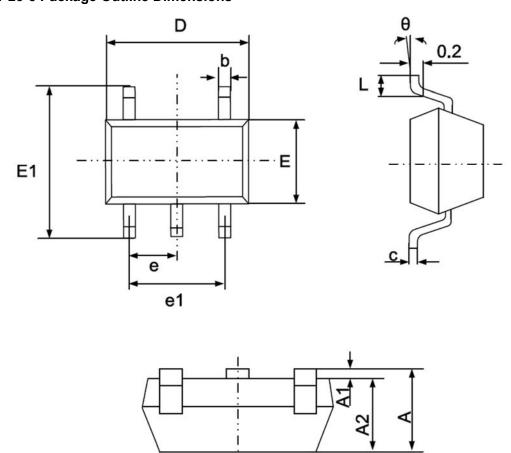
⁽¹⁾ Pulse loading on the BAT pin may cause the IC to cycle between Done and charging states (LEDs Flashing)

■ TYPICAL PERFORMANCE CHARACTERISTICS



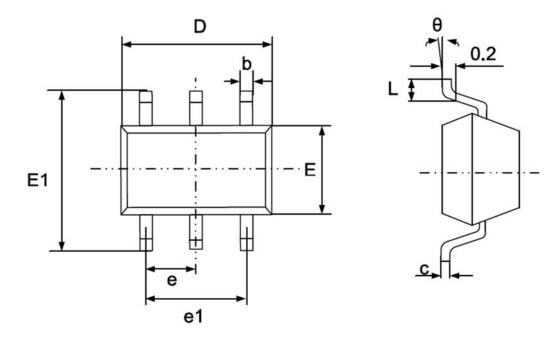
■ PACKAGING INFORMATION

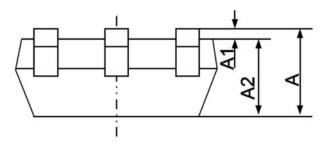
• SOT-23-5 Package Outline Dimensions



Cumbal	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max	Min	Max
Α	1.050	1.250	0.041	0.049
A 1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
С	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
е	0.950	(BSC)	0.037(BSC)
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

SOT-23-6 Package Outline Dimensions





Cumbal	Dimensions In Millimeters		Dimensions In Inches			
Symbol	Min	Max	Min	Max		
Α	1.050	1.250	0.041	0.049		
A1	0.000	0.100	0.000	0.004		
A2	1.050	1.150	0.041	0.045		
b	0.300	0.500	0.012	0.020		
С	0.100	0.200	0.004	0.008		
D	2.820	3.020	0.111	0.119		
E	1.500	1.700	0.059	0.067		
E1	2.650	2.950	0.104	0.116		
е	0.950	950(BSC) 0.0		0.950(BSC) 0.037(BS		BSC)
e1	1.800	2.000	0.071	0.079		
L	0.300	0.600	0.012	0.024		
θ	0°	8°	0°	8°		

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